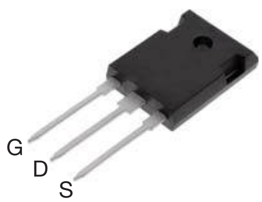
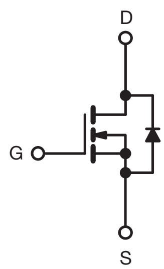
E Series Power MOSFET

PRODUCT SUMMARY		
V_{DS} (V) at T_J max.	650	
$R_{DS(on)}$ max. at 25 °C (Ω)	V_{GS} = 10 V	0.064
Q_g max. (nC)	220	
Q_{gs} (nC)	29	
Q_{gd} (nC)	57	
Configuration	Single	

TO-247AD





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) R_{on} x Q_g
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT

HALOGEN FREE

APPLICATIONS

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW47N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	
Continuous Drain Current (T_J = 150 °C)	V_{GS} at 10 V	T_C = 25 °C	I_D	47	A
		T_C = 100 °C		30	
Pulsed Drain Current [a]			I_{DM}	145	
Linear Derating Factor				3	W/°C
Single Pulse Avalanche Energy [b]			E_{AS}	1800	mJ
Maximum Power Dissipation			P_D	357	W
Operating Junction and Storage Temperature Range			T_J, T_{stg}	-55 to +150	°C
Drain-Source Voltage Slope	V_{DS} = 0 V to 80 % V_{DS}		dV/dt	70	V/ns
Reverse Diode dV/dt [d]				11	
Soldering Recommendations (Peak Temperature) [c]	for 10 s			300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.
b. V_{DD} = 50 V, starting T_J = 25 °C, L = 73.5 mH, R_g = 25 Ω, I_{AS} = 7 A.
c. 1.6 mm from case.
d. $I_{SD} \leq I_D$, dI/dt = 100 A/μs, starting T_J = 25 °C.

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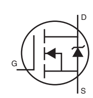
THERMAL RESISTANCE RATINGS				
PARAMETER	**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Maximum Junction-to-Ambient	R_{thJA}	-	40	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.33	

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 μA	600	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, I_D = 250 μA	-	0.66	-	V/°C
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 μA	2	-	4	V
Gate-Source Leakage	I_{GSS}	V_{GS} = ± 20 V	-	-	± 100	nA
		V_{GS} = ± 30 V	-	-	± 1	μA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 600 V, V_{GS} = 0 V	-	-	1	μA
		V_{DS} = 480 V, V_{GS} = 0 V, T_J = 125 °C	-	-	10	
Drain-Source On-State Resistance	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 24 A	-	0.053	0.064	Ω
Forward Transconductance	g_{fs}	V_{DS} = 8 V, I_D = 3 A	-	6.8	-	S
Dynamic						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz	2405	4810	9620	pF
Output Capacitance	C_{oss}		115	230	460	
Reverse Transfer Capacitance	C_{rss}		1.7	5	10	
Effective Output Capacitance, Energy Related [a]	$C_{o(er)}$	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	-	170	-	
Effective Output Capacitance, Time Related [b]	$C_{o(tr)}$		-	604	-	
Total Gate Charge	Q_g	V_{GS} = 10 V, I_D = 24 A, V_{DS} = 480 V	74	148	220	nC
Gate-Source Charge	Q_{gs}		14.5	29	58	
Gate-Drain Charge	Q_{gd}		28.5	57	86	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 480 V, I_D = 24 A, V_{GS} = 10 V, R_g = 4.4 Ω	14	28	56	ns
Rise Time	t_r		36	72	108	
Turn-Off Delay Time	$t_{d(off)}$		47	93	140	
Fall Time	t_f		41	82	123	
Gate Input Resistance	R_g	f = 1 MHz, open drain	0.13	0.65	1.3	Ω
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode 	-	-	47	A
Pulsed Diode Forward Current	I_{SM}		-	-	140	
Diode Forward Voltage	V_{SD}	T_J = 25 °C, I_S = 24 A, V_{GS} = 0 V	-	-	1.2	V
Body Diode Reverse Recovery Time	t_{rr}	T_J = 25 °C, I_F = I_S = 24 A, dI/dt = 100 A/μs, V_R = 25 V	-	582	1164	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	11	22	μC
Reverse Recovery Current	I_{RRM}		-	31	62	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

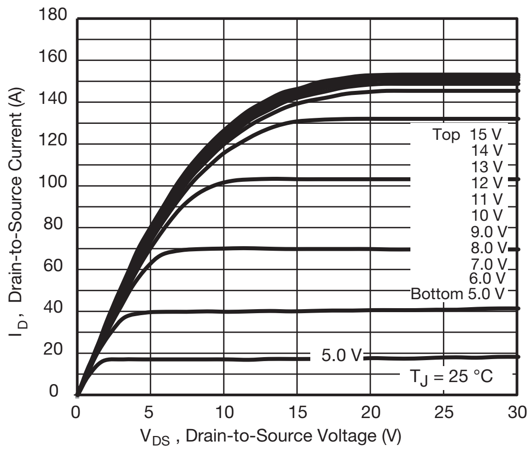

Fig. 1 - Typical Output Characteristics, T_C = 25 °C

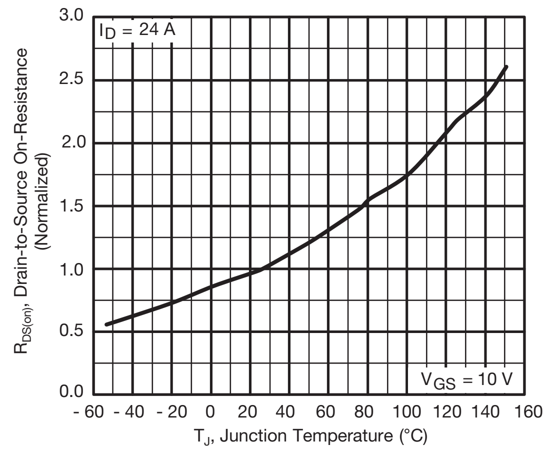

Fig. 4 - Normalized On-Resistance vs. Temperature

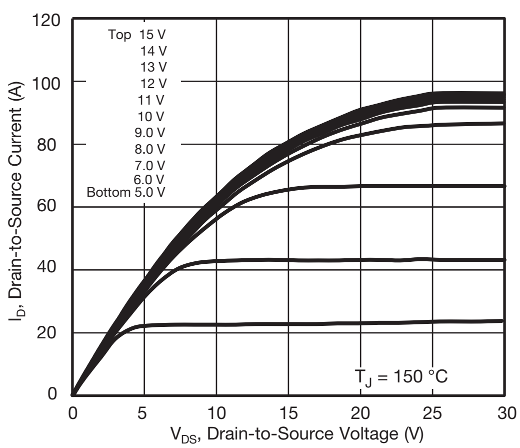

Fig. 2 - Typical Output Characteristics, T_C = 150 °C

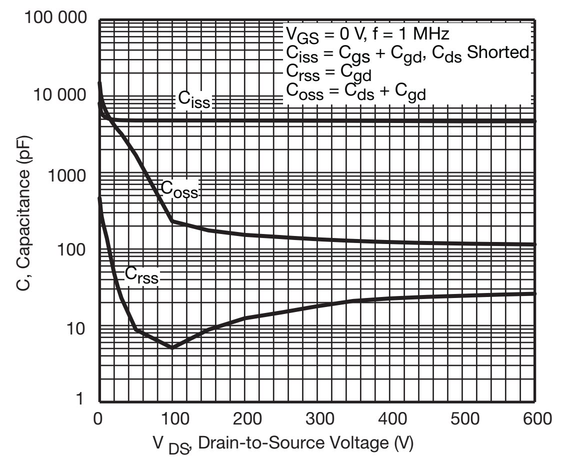

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

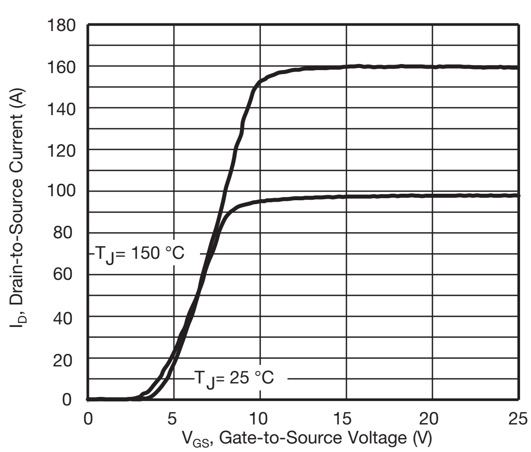

Fig. 3 - Typical Transfer Characteristics

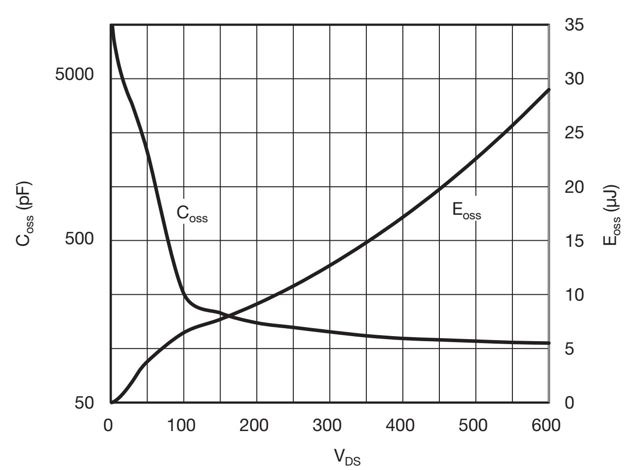

Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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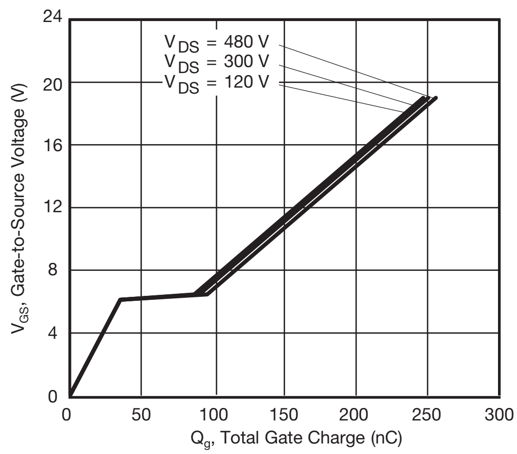


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

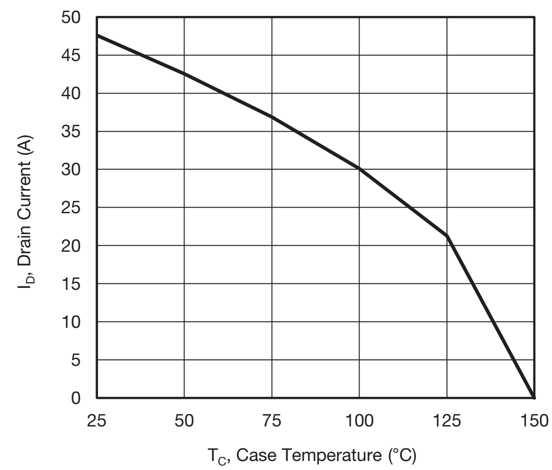


Fig. 10 - Maximum Drain Current vs. Case Temperature

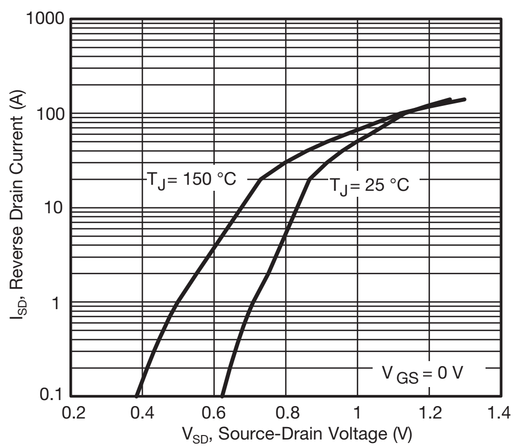


Fig. 8 - Typical Source-Drain Diode Forward Voltage

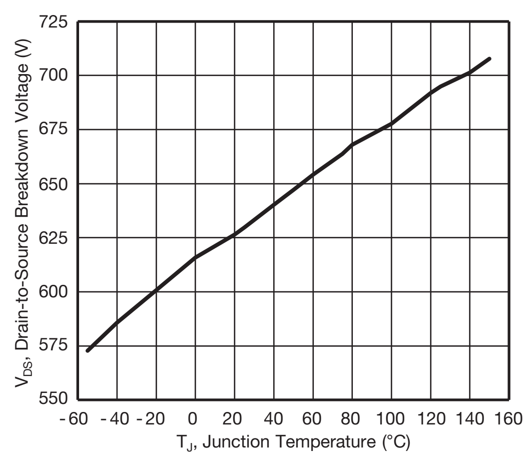
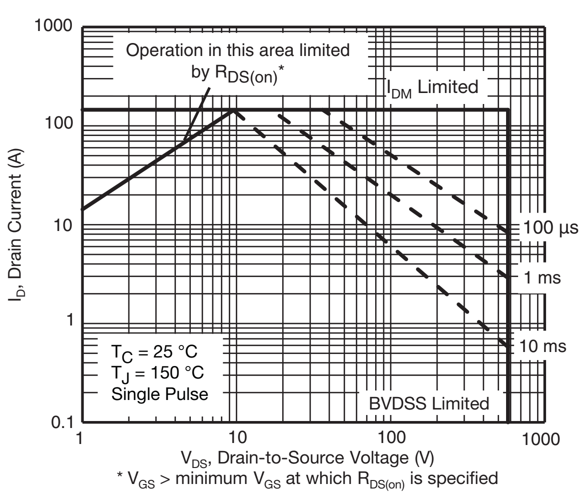


Fig. 11 - Temperature vs. Drain-to-Source Voltage



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Fig. 9 - Maximum Safe Operating Area

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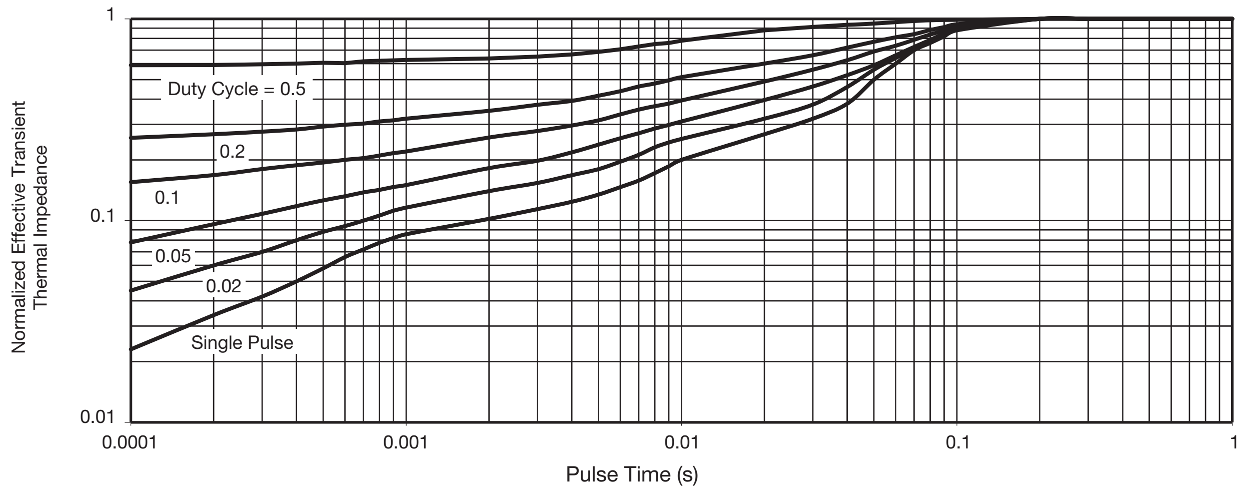

Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

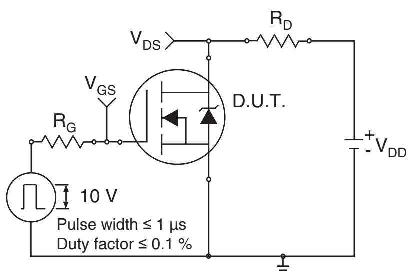

Fig. 13 - Switching Time Test Circuit

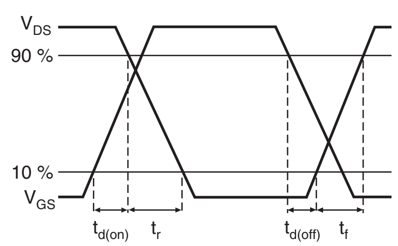

Fig. 14 - Switching Time Waveforms

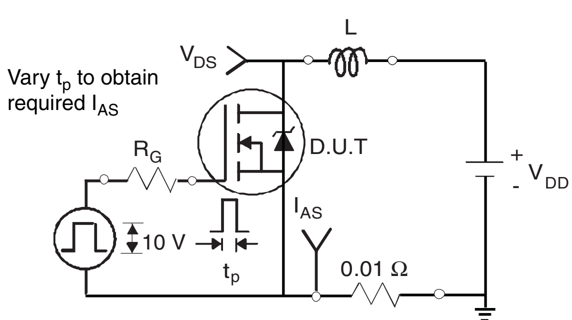

Fig. 15 - Unclamped Inductive Test Circuit

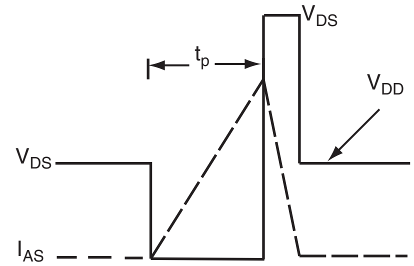

Fig. 16 - Unclamped Inductive Waveforms

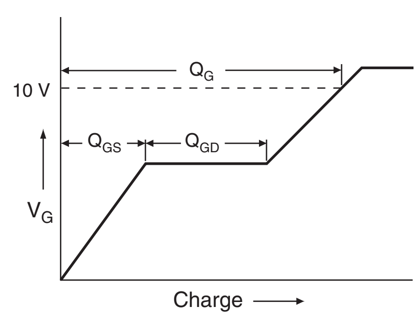

Fig. 17 - Basic Gate Charge Waveform

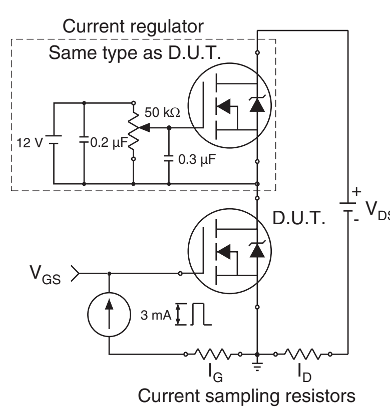

Fig. 18 - Gate Charge Test Circuit

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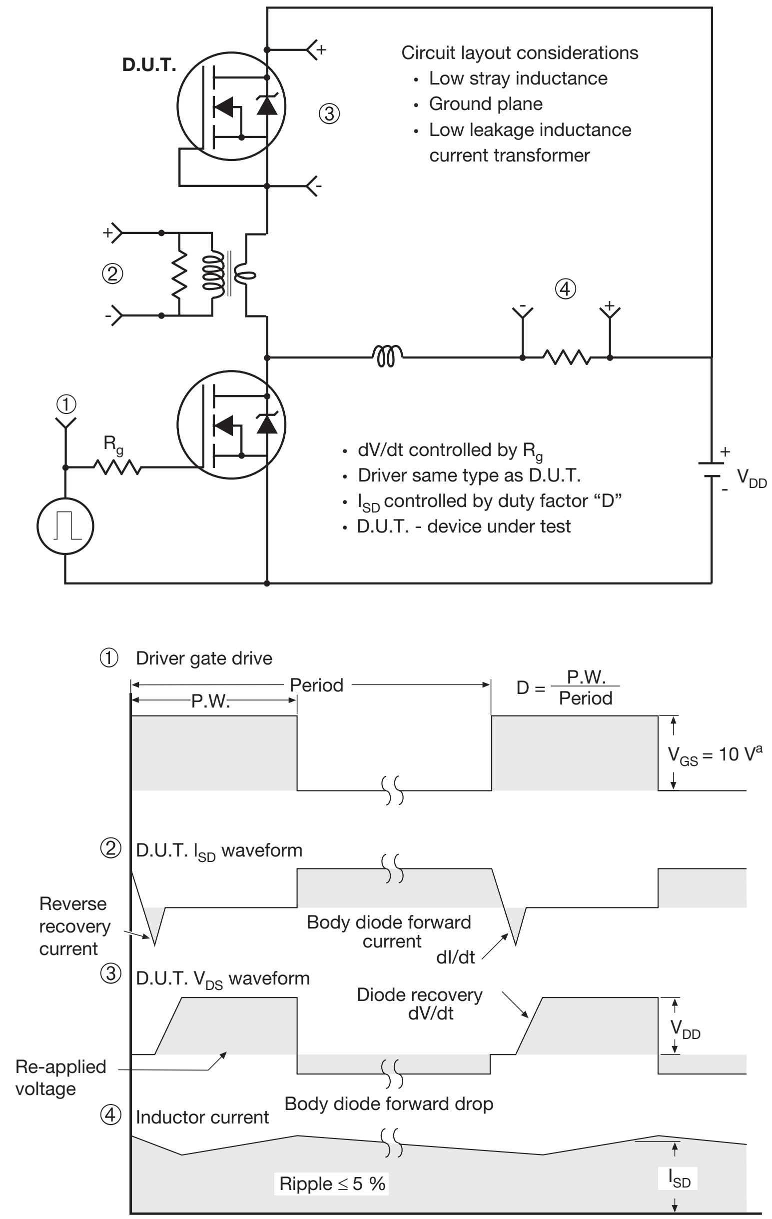
Peak Diode Recovery dV/dt Test Circuit



Note

a. V_{GS} = 5 V for logic level devices

Fig. 19 - For N-Channel

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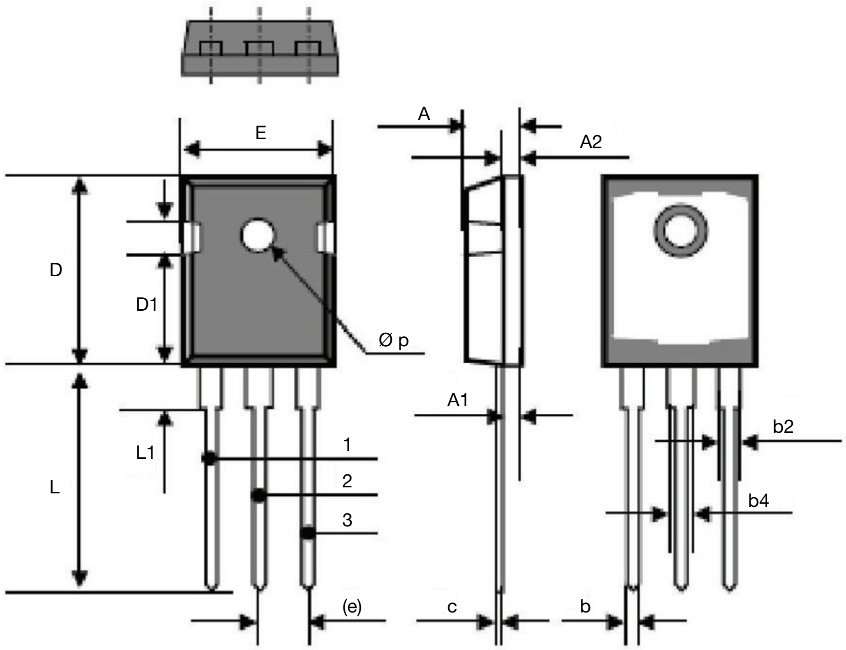
TO-247AD (High Voltage)



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.70	5.31	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	0.99	1.40	0.039	0.055
b2	1.65	2.41	0.065	0.095
b4	2.59	3.43	0.102	0.135
c	0.61 BSC		0.024 BSC	
D	20.80	21.46	0.819	0.845
D1	3.68	5.49	0.145	0.216
(e)	5.46 BSC		0.215 BSC	
E	15.49	16.26	0.610	0.640
L	19.81	20.32	0.780	0.800
L1	4.06	4.50	0.160	0.177
Ø p	3.51	3.66	0.138	0.144
ECN: S17-0178-Rev. B, 06-Feb-17 DWG: 6010				

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